

AR231100

ART35FE, 13.56 MHz

v1.0 — 12 September 2023

AMPLEON

Application Report

Document information

Status General Publication

Abstract Measurement results of a demo board at 13.56 MHz with the ART35FE

1. Revision History

Table 1 Report revisions

Revision	Date	Description	Author
1.0	2023.09.12	Initial document	Gabriel Pasca

2. Contents

- 1. Revision History 2
- 2. Contents 2
- 3. List of figures 2
- 4. List of tables 2
- 5. General description 3
 - 5.1 Simulation Results 5
 - 5.2 RF characteristics 6
 - 5.2.1 Efficiency and Gain vs Output Power in CW mode at different VDS levels 6
 - 5.2.2 Efficiency and Gain vs Output Power in CW mode at different Idq levels 7
 - 5.3 Harmonic Performance 8
 - 5.4 S-Parameter S21 measurements 8
 - 5.5 Thermal characteristics 9
- 6. Hardware 10
 - 6.1 Bill of materials 10
 - 6.2 User Guide 11
 - 6.3 Board specifications 11
- 7. Legal information 12
 - 7.1 Definitions 12
 - 7.2 Disclaimers 12
 - 7.3 Trademarks 12
 - 7.4 Contact information 12

3. List of figures

- Figure 1 Demo top view 3
- Figure 2 Schematic of the demo 4
- Figure 3 Simulated Efficiency vs Output Power 5
- Figure 4 Simulated Gain vs Output Power 5
- Figure 5 Efficiency vs Output Power at different VDS levels 6
- Figure 6 Efficiency and Gain vs Output Power at different VDS levels 6
- Figure 7 Efficiency vs Output Power at different Idq levels 7
- Figure 8 Gain vs Output Power at different Idq levels 7
- Figure 9 Harmonic Performance vs Output Power 8
- Figure 10 S21 (dB) over frequency (MHz), Vdd = 65V, Idq = 500mA, Pin = -20 dBm 8
- Figure 11 IR image of the demo after reaching thermal equilibrium and operating at P3dB, VDD = 65V 9
- Figure 12 Component mapping 10
- Figure 13 Application board pin configuration 11

4. List of tables

- Table 1 Report revisions 2
- Table 2 Test circuit information 3
- Table 3 RF characteristics in CW mode at F=13.56MHz, Idq = 25mA 6
- Table 4 RF characteristics in CW mode at F=13.56MHz, Vds = 65 V 7
- Table 5 Bill of Materials 10
- Table 6 Pin Description 11

Table 7 Device specifics 11

5. General description

This report presents an evaluation of a demo board designed as a driver for the 13.56 MHz ISM frequency band, utilizing the ART35FE transistor built on 65V ART technology. This band is prevalent in a wide array of Industrial, Scientific, and Medical (ISM) applications, such as plasma generation, food processing, industrial heating & drying and material processing.

The printed circuit boards (PCBs) were securely fastened using screws, eliminating the need for soldering the board itself. However, the transistor was connected via soldering to ensure optimal electrical conductivity and mechanical stability. The demo board is impedance-matched to 50 Ω at both the input and output, making it compatible with standard RF equipment and test setups.

Figures 1 and 2 showcase the top view of the demo board and its corresponding schematic, providing visual insights into its design and configuration.

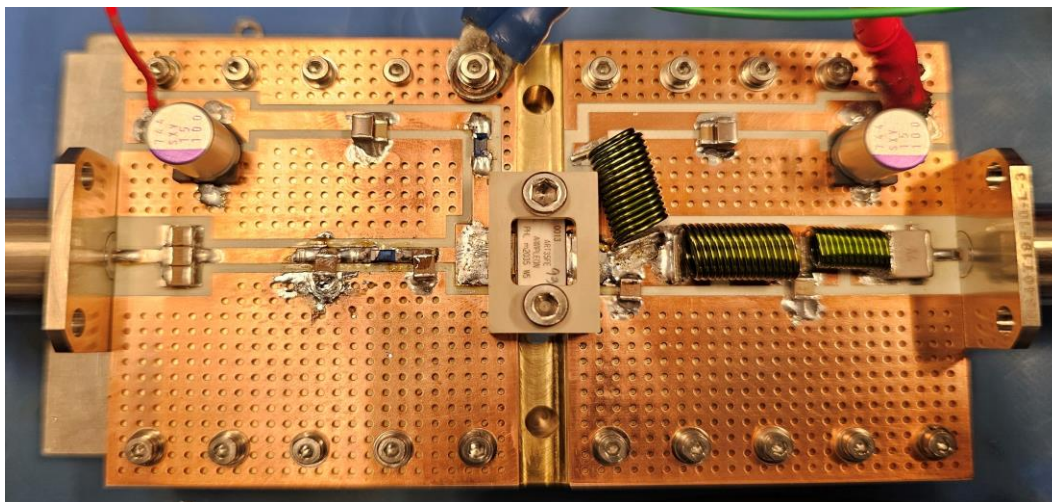


Figure 1 Demo top view

Parameter	Description	Unit
Laminate Type	Rogers 4350B	
Dk	3.48	
Df	0.0037 @10 GHz	
Laminate thickness	0.762	mm
Copper thickness	1 oz top/bottom	
Overall dimensions	106 x 60	mm
Cooling type	Indirect water cooling	
Device Package	SOT467	

Table 2 Test circuit information

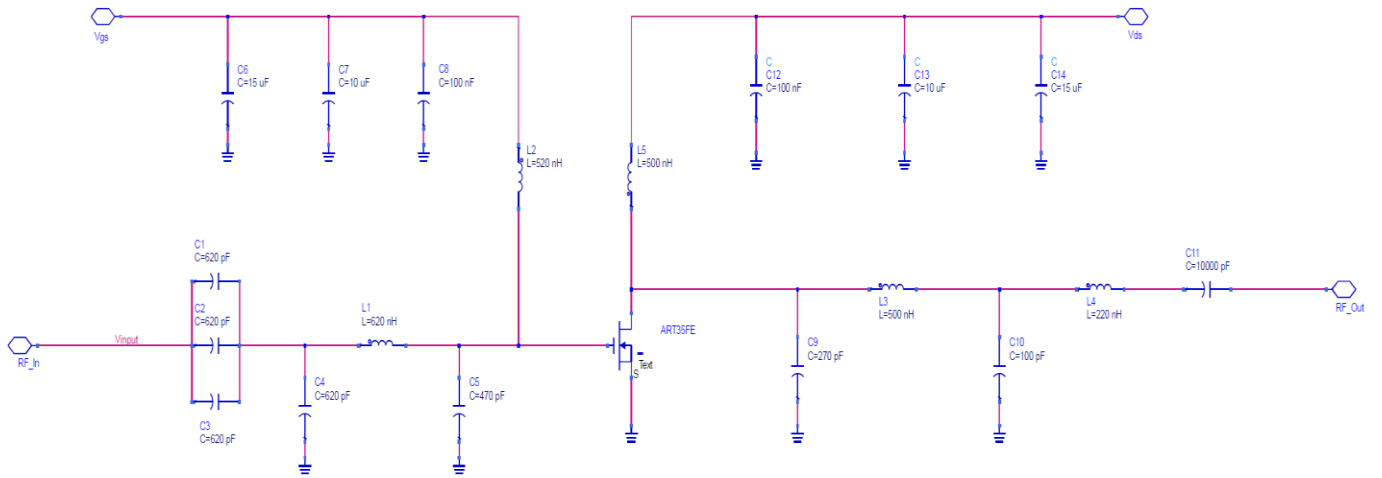


Figure 2 Schematic of the demo

5.1 Simulation Results

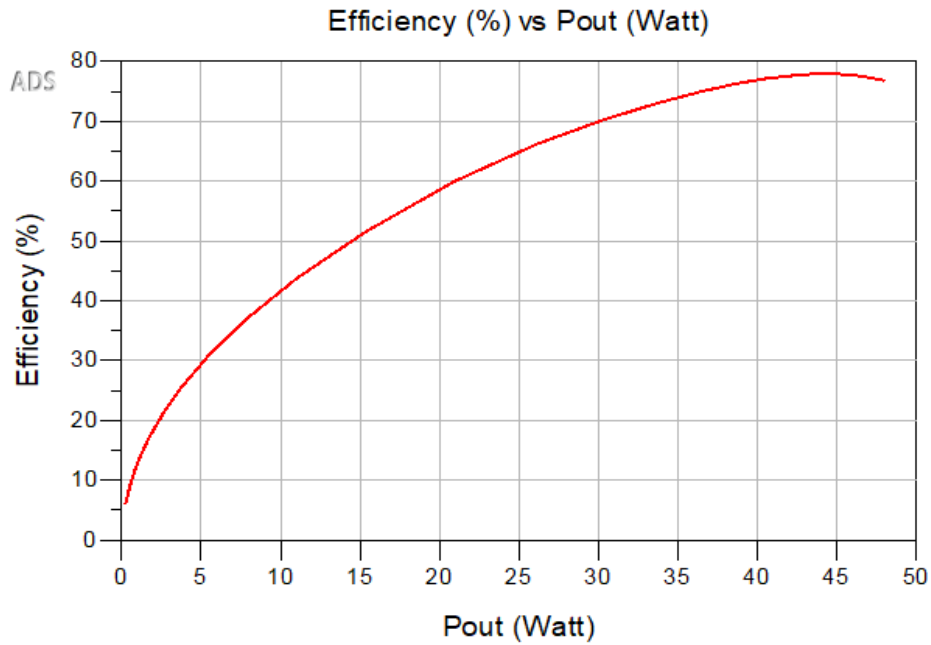


Figure 3 Simulated Efficiency vs Output Power

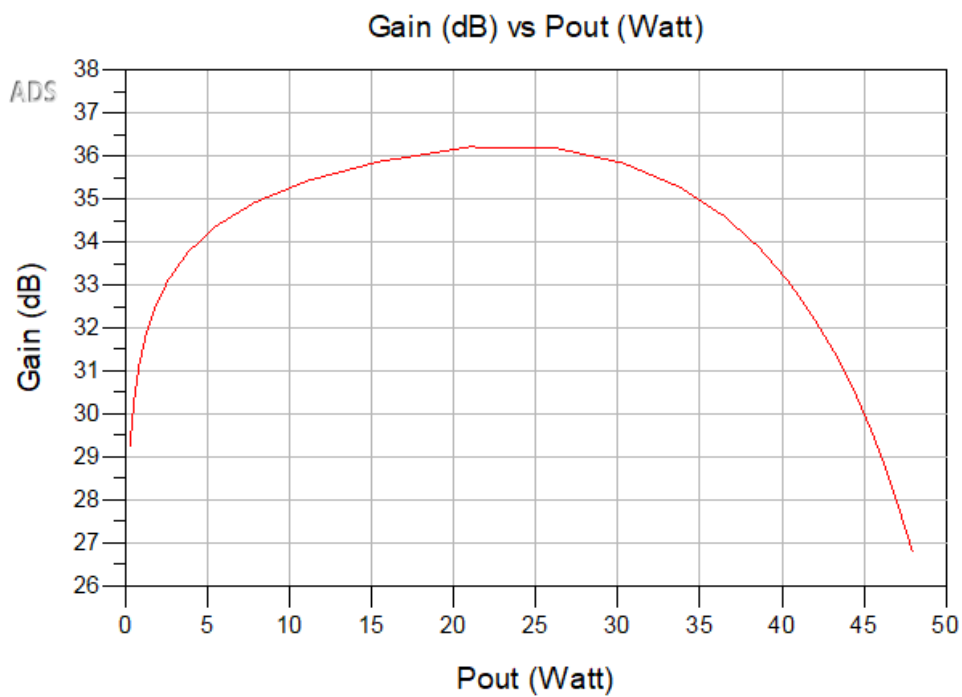


Figure 4 Simulated Gain vs Output Power

5.2 RF characteristics

5.2.1 Efficiency and Gain vs Output Power in CW mode at different VDS levels

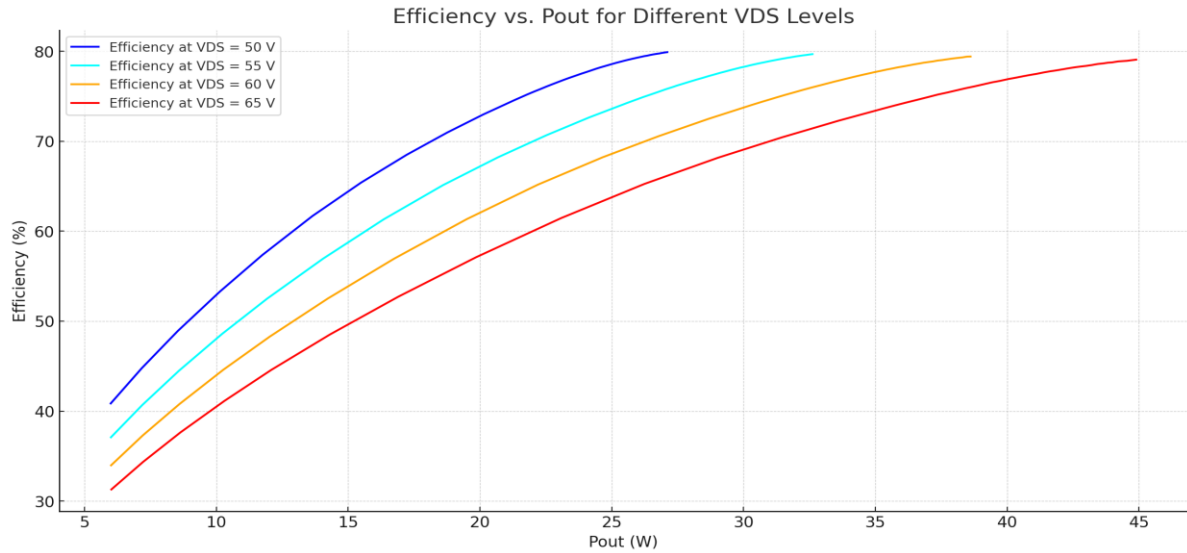


Figure 5 Efficiency vs Output Power at different VDS levels

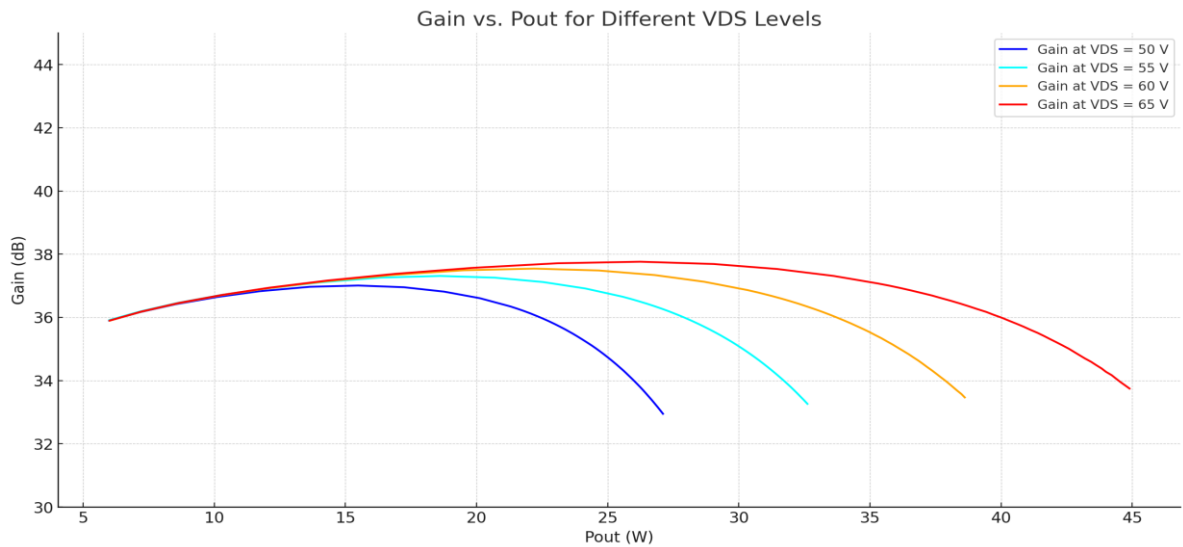


Figure 6 Efficiency and Gain vs Output Power at different VDS levels

V _{DS} (V)	G _{max} (dB)	P _{1dB} (W)	P _{2dB} (W)	P _{3dB} (W)	Eff_P1dB (%)	Eff_P2dB (%)	Eff_P3dB (%)
50	29.2	22	25	26	75.9	78.2	79.3
55	29.4	27	29	31	75.6	77.9	79.0
60	37.5	32	35	37	75.3	77.6	78.8
65	37.7	37	40	43	74.9	77.2	78.4

Table 3 RF characteristics in CW mode at F=13.56MHz, Idq = 25mA

5.2.2 Efficiency and Gain vs Output Power in CW mode at different Idq levels

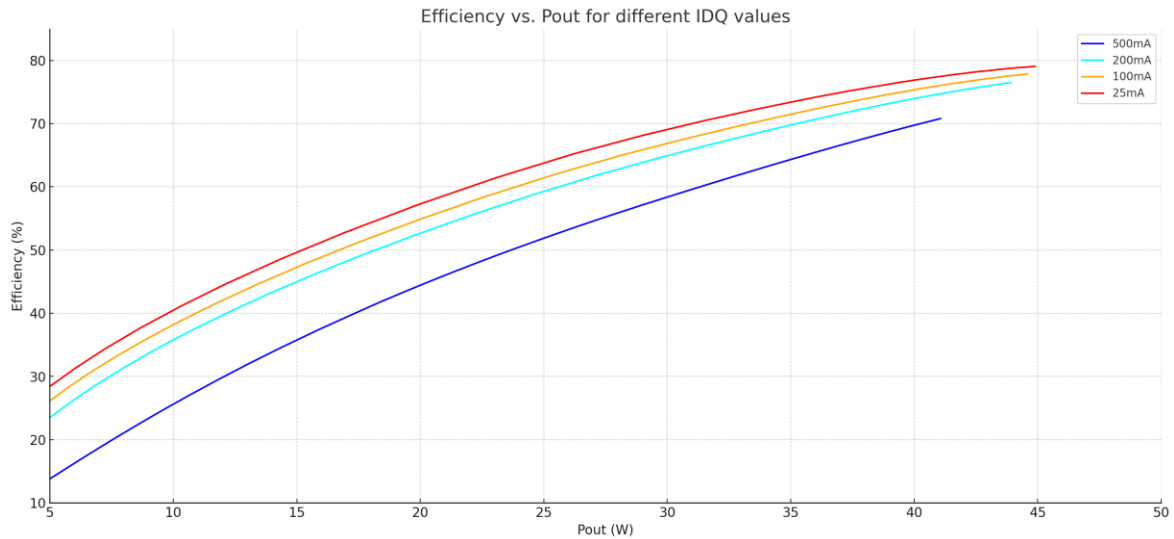


Figure 7 Efficiency vs Output Power at different Idq levels

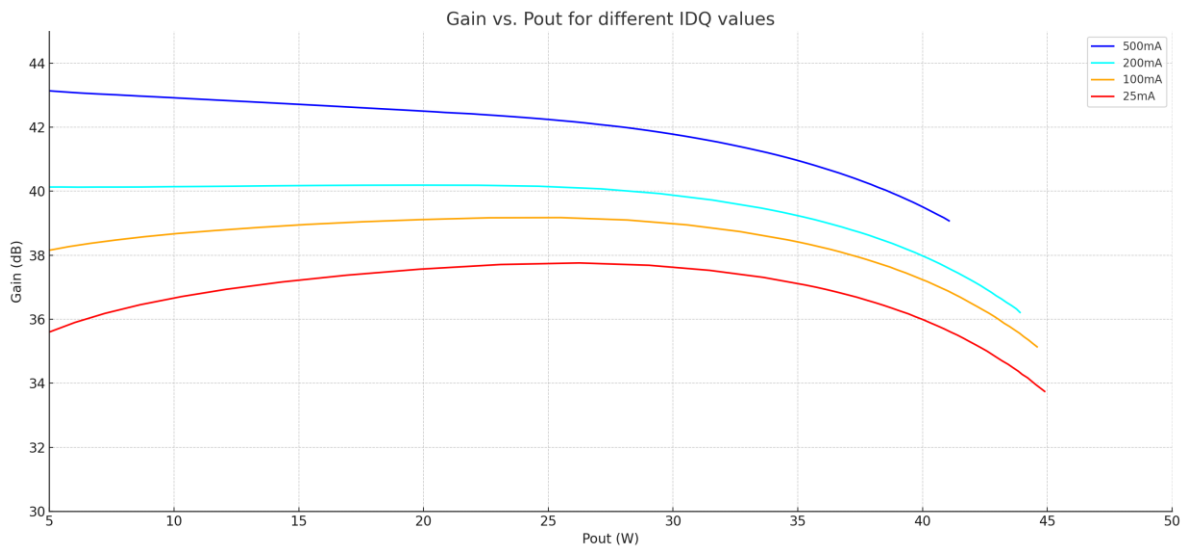


Figure 8 Gain vs Output Power at different Idq levels

$I_{Dq}(mA)$	Gmax (dB)	P1dB (W)	P2dB (W)	P3dB (W)	Eff_P1dB (%)	Eff_P2dB (%)	Eff_P3dB (%)
25	37.7	37	40	43	74.9	77.2	78.4
100	39.2	36	40	42	72.6	75.5	76.9
200	40.2	35	39	42	69.8	73.4	75.3
500	43.1	26	34	38	53.9	63.3	67.8

Table 4 RF characteristics in CW mode at $F=13.56MHz$, $V_{ds} = 65 V$

5.3 Harmonic Performance

The focused plot for the ART35FE between 5W to 45W at 13.56 MHz reveals key insights for its role as a driver in high-power RF applications. The harmonic levels indicate effective suppression of unwanted frequencies and validate the device's design for optimal performance. This range-specific analysis is critical for ensuring the ART35FE can reliably drive subsequent amplification stages in various applications.

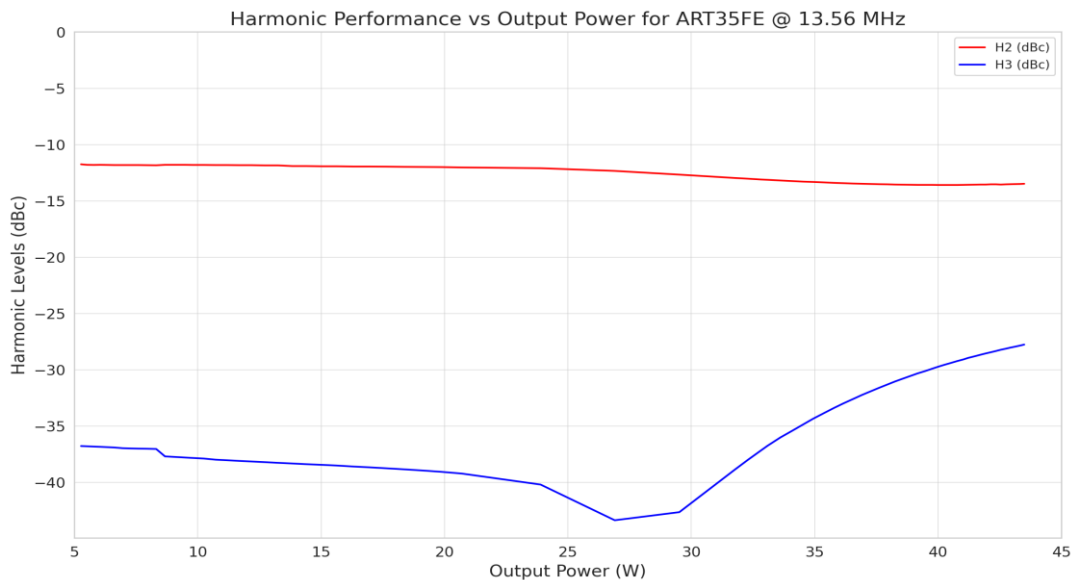


Figure 9 Harmonic Performance vs Output Power

5.4 S-Parameter S21 measurements

The S21 S-parameters in Figure 11 indicate a peak at 13.56 MHz, which aligns with the ISM band specifications for target applications. This peak is an indicator of maximum power transfer, high efficiency, and low harmonic distortion in real-world applications.

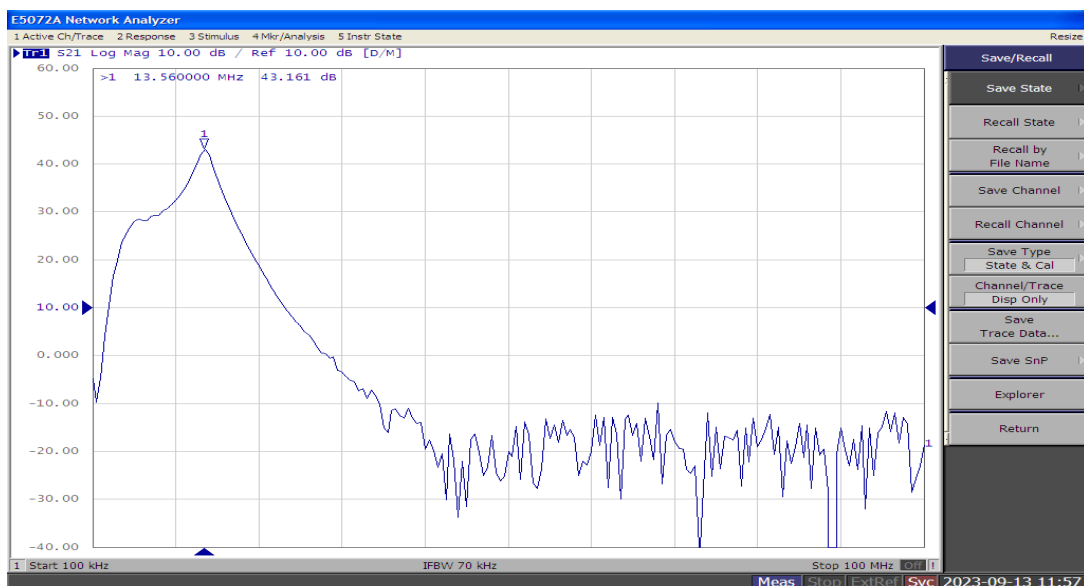


Figure 10 S21 (dB) over frequency (MHz), Vdd = 65V, Idq = 500mA, Pin = -20 dBm

5.5 Thermal characteristics

Figure 12 presents an infrared (IR) thermal image of the demo board after it has reached a state of thermal equilibrium in a no-cooling environment. The highest recorded temperature on the device under these conditions is $T_{case} = 58^{\circ}C$, the ambient temperature $T_{ambient} = 25^{\circ}C$

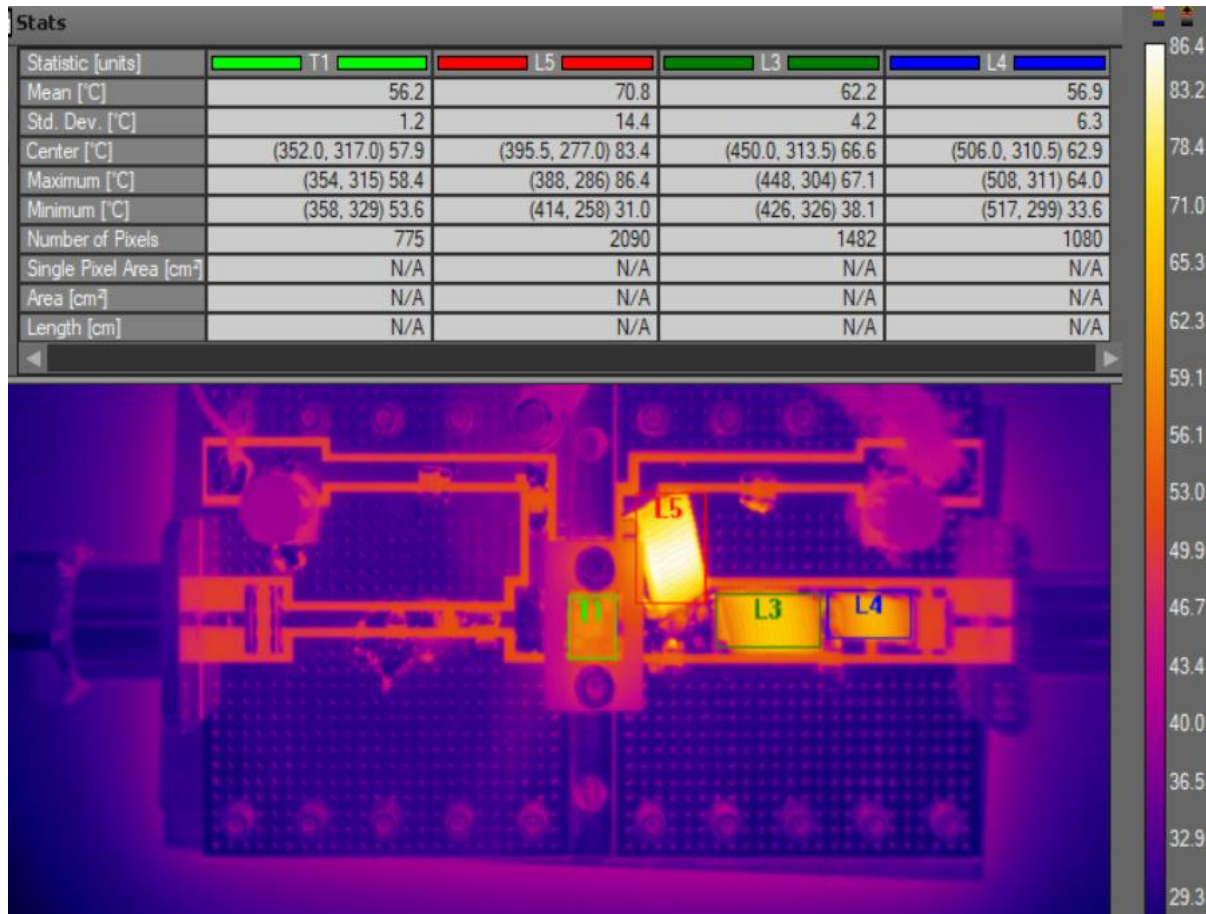


Figure 11 IR image of the demo after reaching thermal equilibrium and operating at P3dB, VDD = 65V

6. Hardware

6.1 Bill of materials

Designator	Group	Value	Tolerance	Name	Manufacturer	Quantity
C1, C2, C3, C4	Capacitor	620pF	±2%	800B621GT100XT	KYOCERA AVX	4
C5	Capacitor	470pF	±2%	800B471GT200XT	KYOCERA AVX	1
C6, C14	Capacitor	15uF	±20%	100SXV15M	Panasonic	2
C7, C13	Capacitor	10uF	±10%	GRM32EC72A106KE05L	Murata	2
C8, C12	Capacitor	0.1uF	±10%	GRM188R72A104KA35D	Murata	2
C9	Capacitor	270pF	±2%	800B271GT200XT	KYOCERA AVX	1
C10	Capacitor	100pF	±2%	800B101GT500XT	KYOCERA AVX	1
C11	Capacitor	10nF	±5%	222522000103JQTAF9LM	Knowles Syfer	1
L1	Inductor	620nH	±5%	1206CS-621XJE	Coilcraft	1
L2	Inductor	560nH	±5%	1206CS-561XJE	Coilcraft	1
L3	Inductor	500nH 4.3A	±2%	2929SQ-501GEC	Coilcraft	1
L4	Inductor	220nH	±2%	2222SQ-221GEC	Coilcraft	1
L5	Inductor	500nH 4.3A	±2%	2929SQ-501GEC	Coilcraft	1
Q1	Transistor	35 W		ART35FE	Ampleon	1
X1	Connector			13_N-50-0-33/133_NE	HUBER+SUHNER	1
X2	Connector			23_N-50-0-33/133_NE	HUBER+SUHNER	1
PCB In	Board			ART35FE-DB1-013 IN	Cibel	1
PCB Out	Board			ART35FE-DB1-013 OUT	Cibel	1

Table 5 Bill of Materials

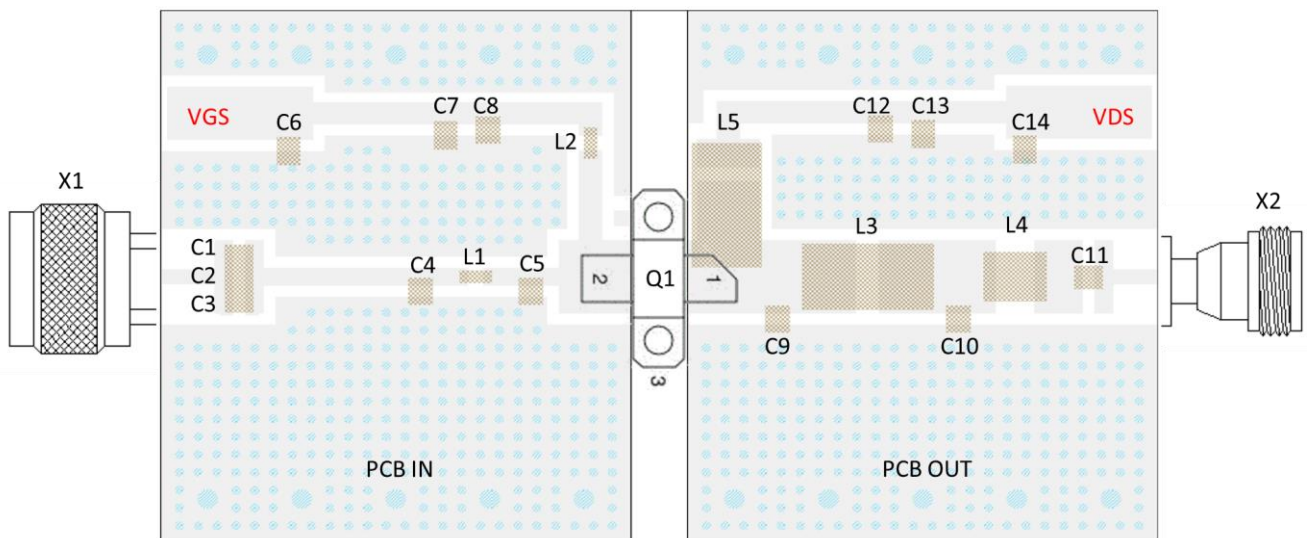


Figure 12 Component mapping

6.2 User Guide

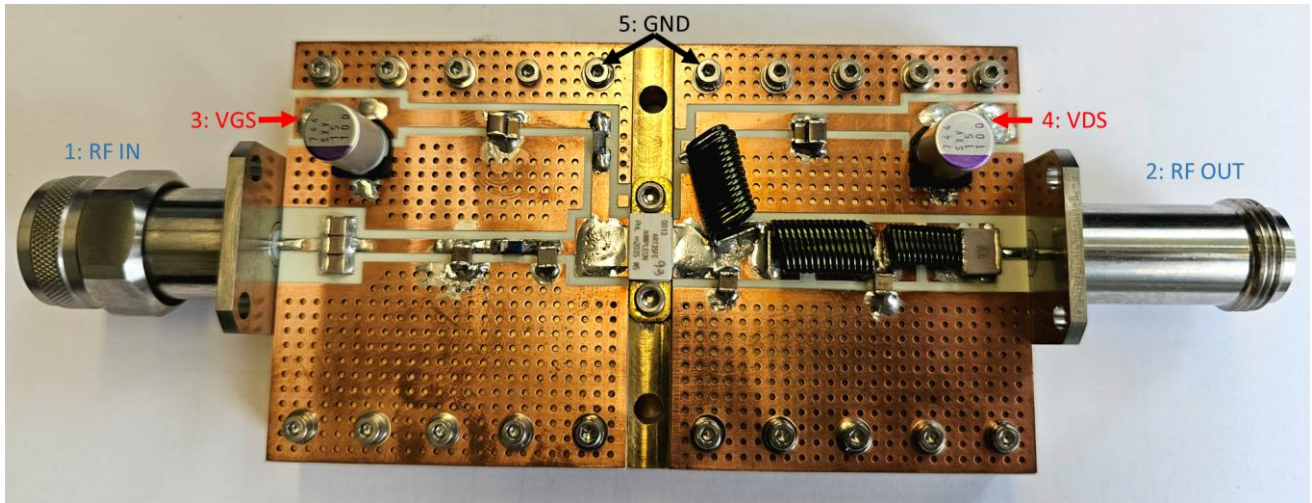


Figure 13 Application board pin configuration

Symbol	Pin	Description
RFIN	1	RF input
RFOUT	2	RF output
VGS	3	Gate-source voltage
VDS	4	Drain-source voltage
GND	5	Negative supply terminal for V_{DS} and V_{GS}

Table 6 Pin Description

6.3 Board specifications

Parameter	Value
Manufacturer	Ampleon
Device	ART35FE
PCB marking	ART35FE-DB1-013

Table 7 Device specifics

7. Legal information

7.1 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Ampleon does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

7.2 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Ampleon does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Ampleon takes no responsibility for the content in this document if provided by an information source outside of Ampleon.

In no event shall Ampleon be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Ampleon's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Ampleon.

Right to make changes — Ampleon reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Ampleon products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Ampleon product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Ampleon and its suppliers accept no liability for inclusion and/or use of Ampleon products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

7.4 Contact information

For more information, please visit: <http://www.ampleon.com>

For sales office addresses, please visit: <http://www.ampleon.com/sales>

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Ampleon makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Ampleon products, and Ampleon accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Ampleon product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Ampleon does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Ampleon products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Ampleon does not accept any liability in this respect.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

7.3 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Any reference or use of any 'NXP' trademark in this document or in or on the surface of Ampleon products does not result in any claim, liability or entitlement vis-à-vis the owner of this trademark. Ampleon is no longer part of the NXP group of companies and any reference to or use of the 'NXP' trademarks will be replaced by reference to or use of Ampleon's own trademarks.